



ELECTRONIC SOLDERS

TECHNICAL DATA SHEET

LEAD-FREE ALLOYS

96.5% Tin/3.5% Silver & 96% Tin/4% Silver



DESCRIPTION

Tin/Silver Alloys are compatible with most major electronic grade fluxes on the market today, and are available in paste and wire form in no-clean, water soluble and rosin chemistries.

FEATURES

Excellent resistance
Excellent solder joint reliability
High Purity
Compatible with most flux types
Mfg. to J-Std-006

TEMPERATURE REQUIREMENTS

APPLICATION	RECOMMENDED TEMPERATURE
REFLOW SOLDERING	PEAK TEMPERATURE 240 – 250 C (464 – 482 F)
WAVE SOLDERING	POT TEMPERATURE OF 260 C (500 F)
HAND SOLDERING	TIP TEMPERATURE OF 355 – 410C (700 – 800F)

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